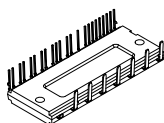


MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

ON Semiconductor®

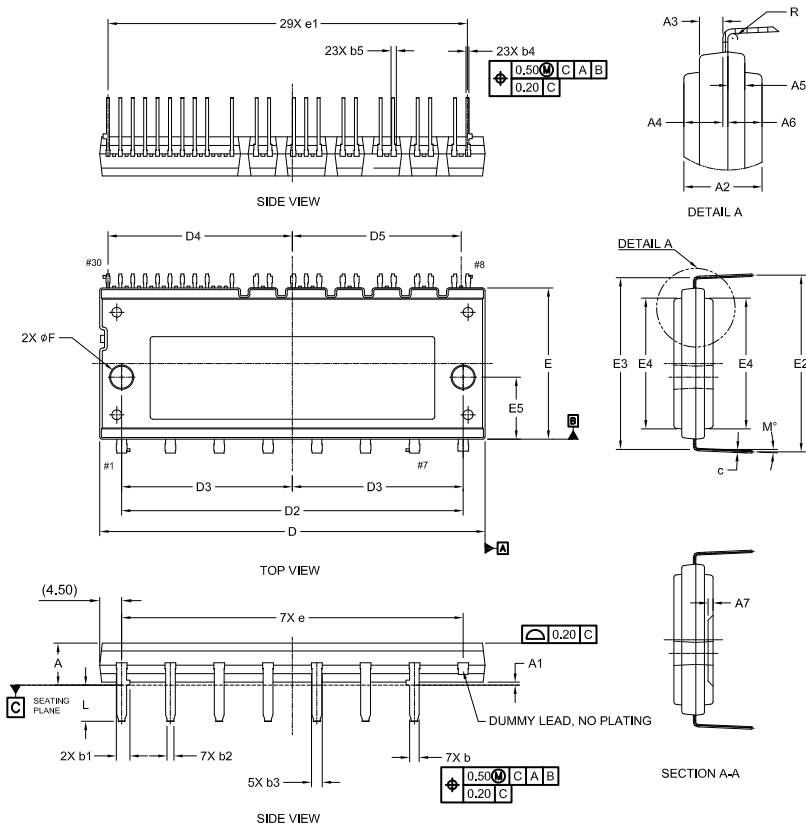


DIP30, 79x30/SPM49 CAA CASE MODGR ISSUE A

DATE 27 JUN 2019

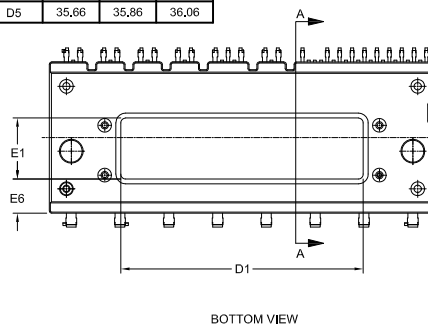
NOTES:

1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b and c APPLY TO THE PLATED LEADS AND ARE MEASURED BETWEEN 1.00 AND 2.00 FROM THE LEAD TIP.
4. POSITION OF THE LEAD IS DETERMINED AT THE ROOT OF THE LEAD WHERE IT EXITS THE PACKAGE BODY.

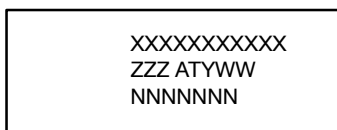


DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	8,40	8,60	8,80
A1	0,40	0,60	0,80
A2	7,90	8,00	8,10
A3	2,30	2,40	2,50
A4	3,90	4,00	4,10
A5	1,65	1,75	1,85
A6	3,40	3,50	3,60
A7	1,00 REF		
b	1,90	2,00	2,10
b1	—	—	2,80
b2	1,40 REF		
b3	—	—	2,20
b4	0,50	0,60	0,70
b5	—	—	0,80
c	0,45	0,50	0,60
D	78,80	79,00	79,20
D1	49,50	49,70	49,90
D2	69,85	70,00	70,15
D3	34,80	35,00	35,20
D4	37,60	37,80	38,00
D5	35,66	35,86	36,06

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
E	30,80	31,00	31,20
E1	12,30	12,50	12,70
E2	35,75	36,20	36,65
E3	35,17 REF		
E4	26,60	26,80	27,00
E5	12,55	12,70	12,85
E6	6,80	7,00	7,20
e	10,00 BSC		
e1	2,54 BSC		
F	4,40	4,50	4,60
L	7,40 REF		
M	—	—	5,0°
R	0,50 REF		



GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code
 ZZZ = Assembly Lot Code
 AT = Assembly & Test Location
 Y = Year
 W = Work Week
 NNN = Serial Number

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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